

Manufacturing Instruction:

- Material FR-4

- Finished thickness: 1.57 mm ± 0.13 mm

- Surface finish: HASL

- PCBs need not to be RoHS compliant

- Do not edit artwork, e.g. to add logos or order numbers

- Clean to meet IPC J-STD-001E, Class 2 after assembly

Stackup:

Material	Thickness	
Copper	35 μm	
Core	1.5 mm	
Copper	35 μm	

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